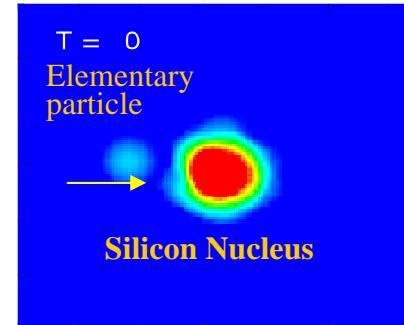
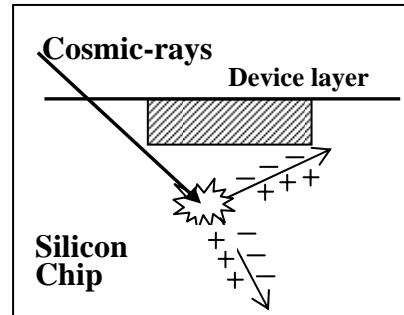
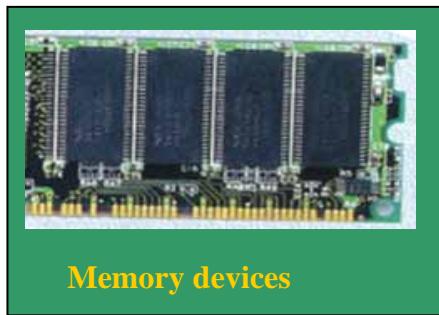


# **Nuclear data relevant to single event upsets in semiconductor memories induced by cosmic-ray neutrons and protons**

**- *Role of nuclear data in our IT society* -**



**Yukinobu Watanabe**  
*Department of Advanced Energy Engineering Science,  
Kyushu University*

# Table of Contents

---

1. Introduction
2. Model for SEU simulation and nuclear data
3. Results and discussion
4. Summary and future plans



*In cooperation with*

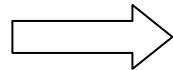
*Akihiro Kodama and Kouta Nishijima*

# Introduction

---

## Single-Event Upset (SEU)

- One of the radiation effects caused in microelectronic devices (e.g., semiconductor memory devices) used in various radiation environments
- When a memory device is exposed to radiations, the memory state of a cell can be flipped from a 1 to a 0 or vice versa, resulting in malfunction caused by an error in a bit.
- “Transient” effects caused by a single ionizing particle



**Soft Error or Soft Failure**

The SEUs (Soft errors) in devices and circuits have recently been recognized as a key **reliability concern** for many current and future silicon-based integrated circuit technologies.

November 13, 2000

*Note that the cosmic-ray induced SEU was predicted by Ziegler@IBM and Landford@Yale Univ. (1979).*

## *Sun Screen*

THE MYSTERIOUS GLITCH has been popping up since late last year. At a new Web company in San Francisco, a telecommunications company in the Midwest, a Baby Bell in Atlanta, an Internet domain registry on the East Coast--for no apparent reason, **high-end servers made by Sun Microsystems suddenly crashed.**

.....

Sun says it has finally figured out what's wrong. **It is an odd problem involving stray cosmic rays** and memory chips in the flagship Enterprise server line, whose models are priced at \$50,000 to more than \$1 million. Yet Sun won't fix all of the servers it has sold; instead it will make repairs when it deems them necessary.

# Rough estimation of SER in our daily life

**1000 FIT** = mean time to failure : **114 year (= $10^6$  hr) / device**

## Cell phone

4Mbit memory with **1000FIT/1Mbit** on board

**1 error / 28 year**

## Network equipment having SRAM with **600FIT/1Mbit** on board

High-end router : 10Gbit SRAM

**1 error / 170 hours**

100Gbit SRAM

**1 error / 17 hours**

## Laptop PC in airplane

600FIT/1Mbit → **100,000 FIT/1Mbit@10,000 m in altitude**

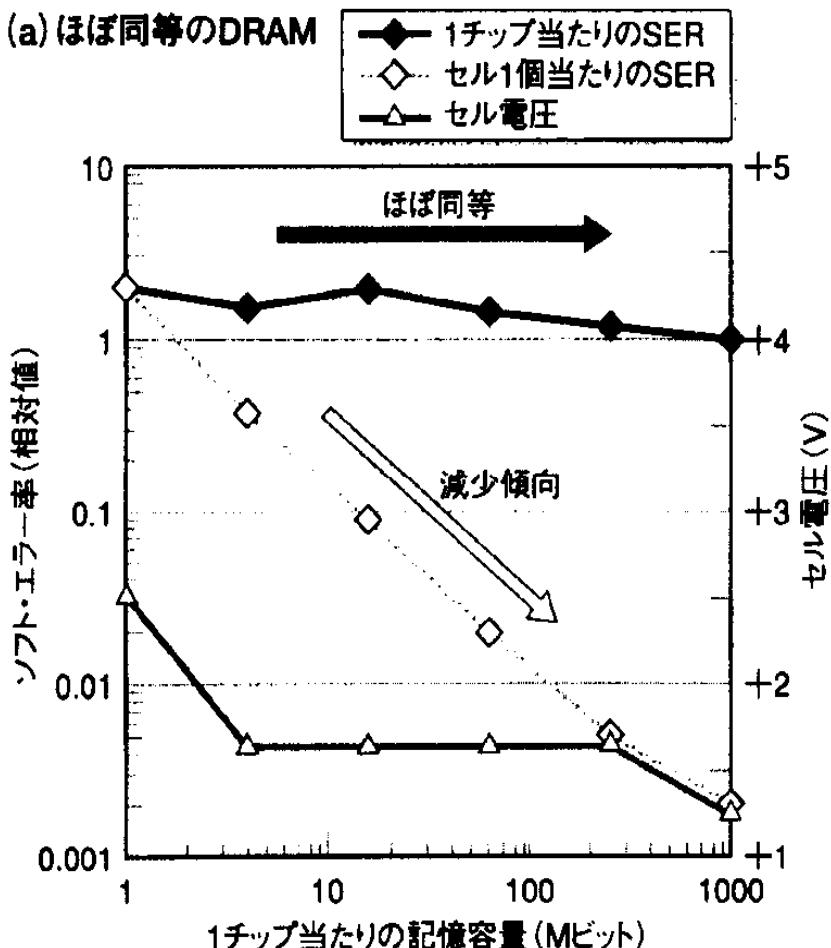
256MB (2Gbit) memories on board

**1 error / 5 hours**

# Soft error rate in DRAM and SRAM

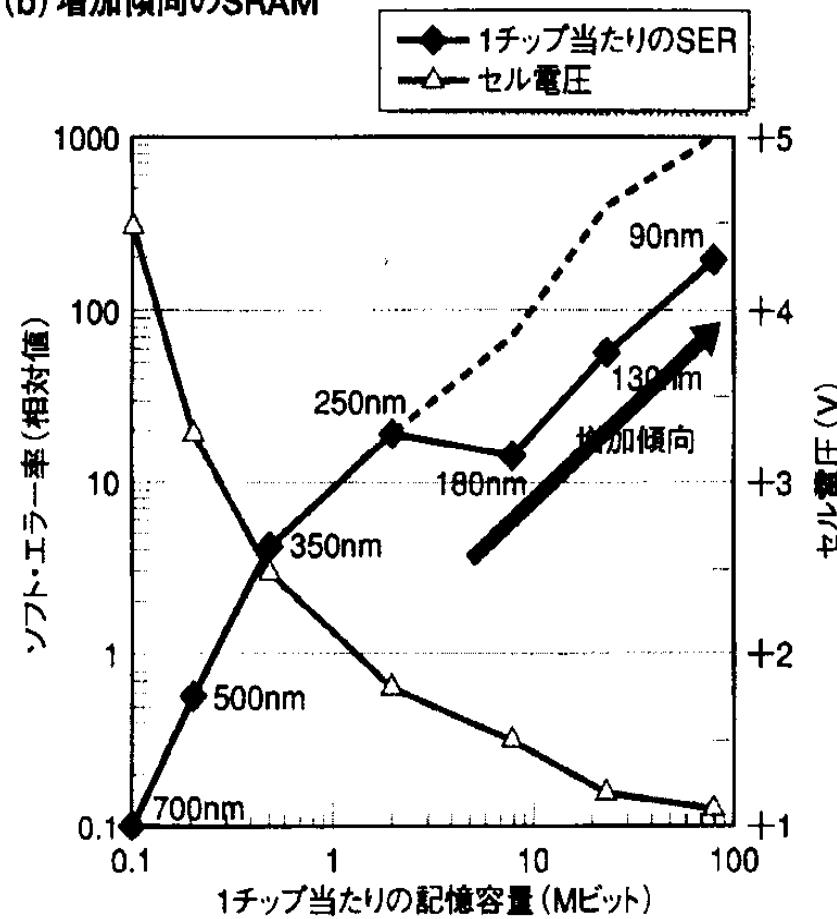
## DRAM

(a) ほぼ同等のDRAM



## SRAM

(b) 増加傾向のSRAM

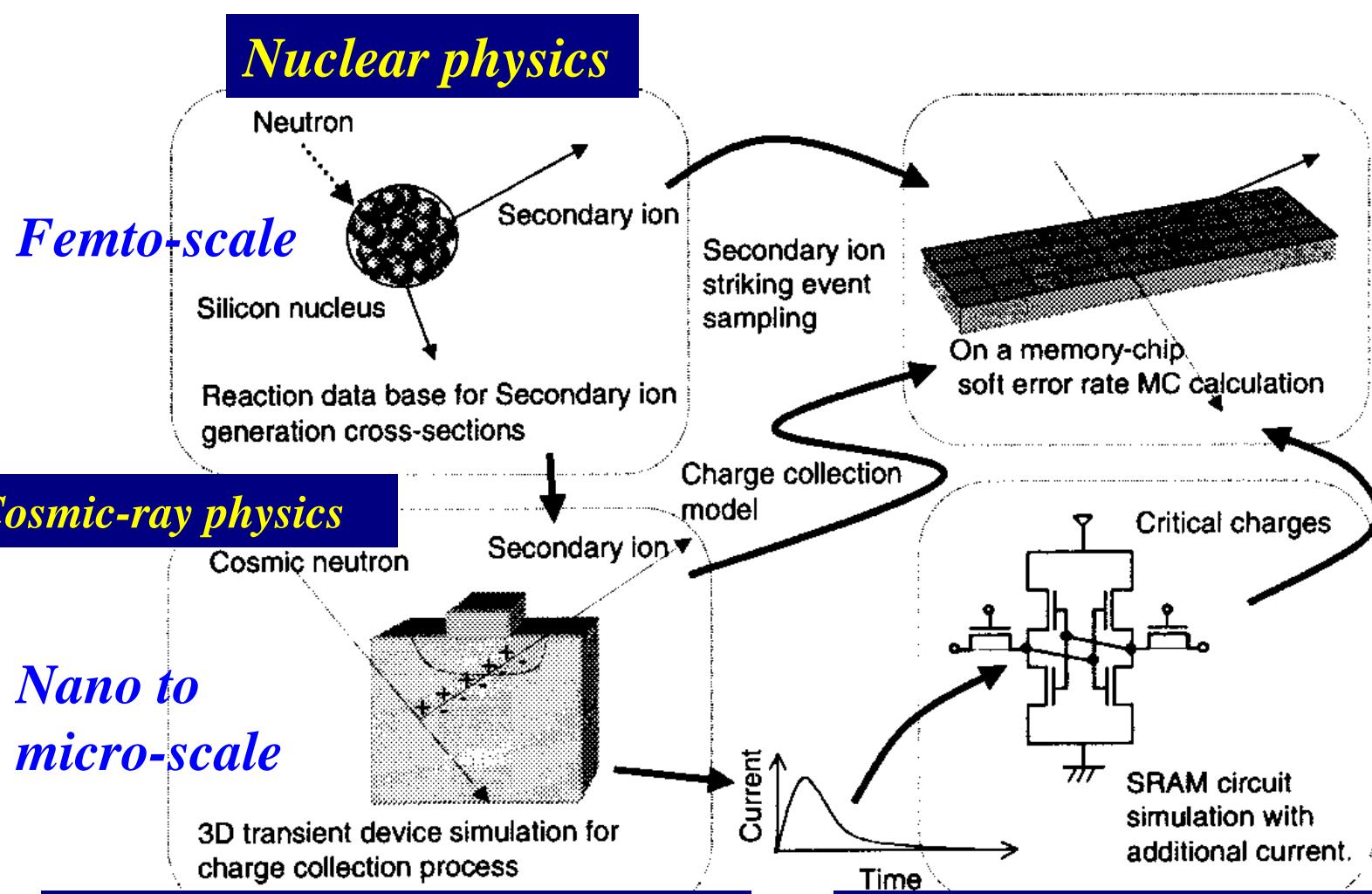


引用)

日経エレクトロニクス2005.7.4

# Physics related for SEU phenomena

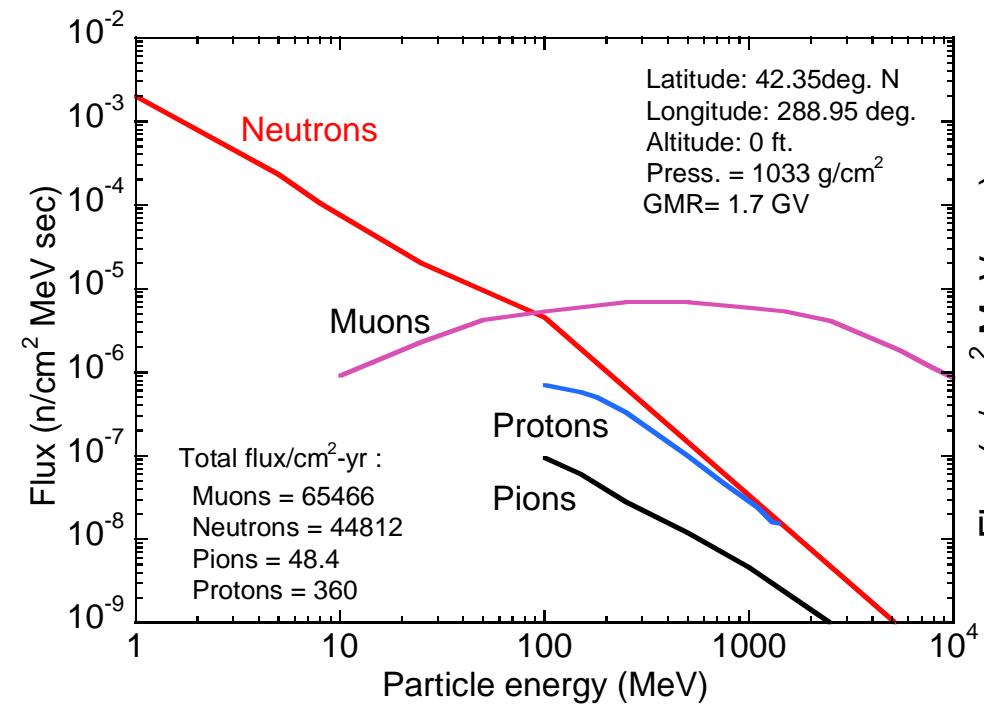
## *Multi-physics & Multi-scale simulation*



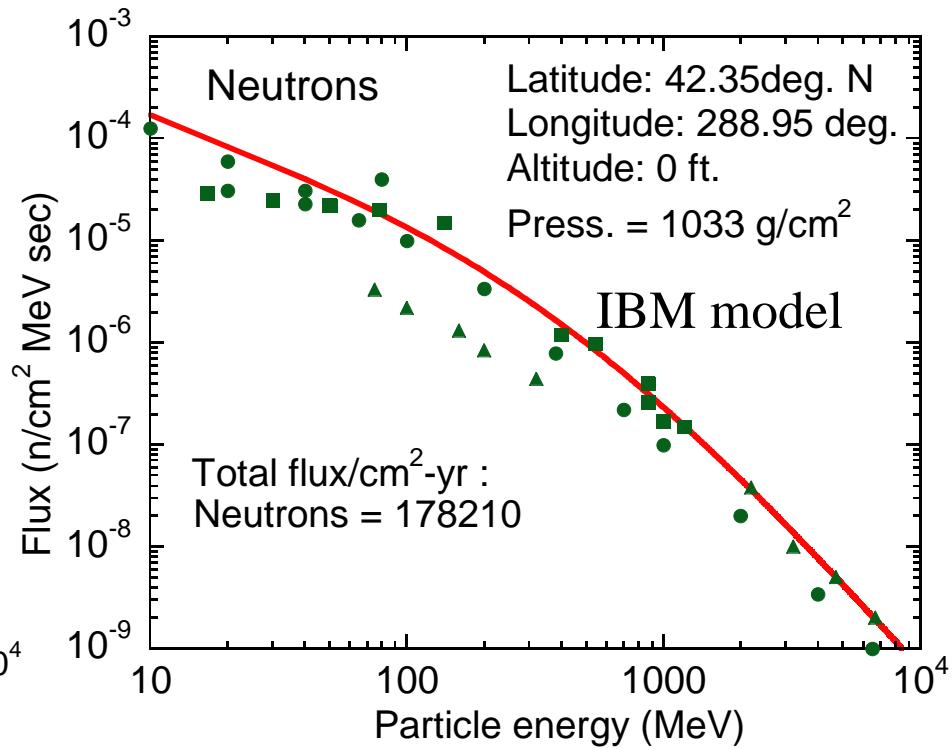
*Atomic and radiation physics*

*Device physics and engineering*

# Cosmic-ray environment on the earth

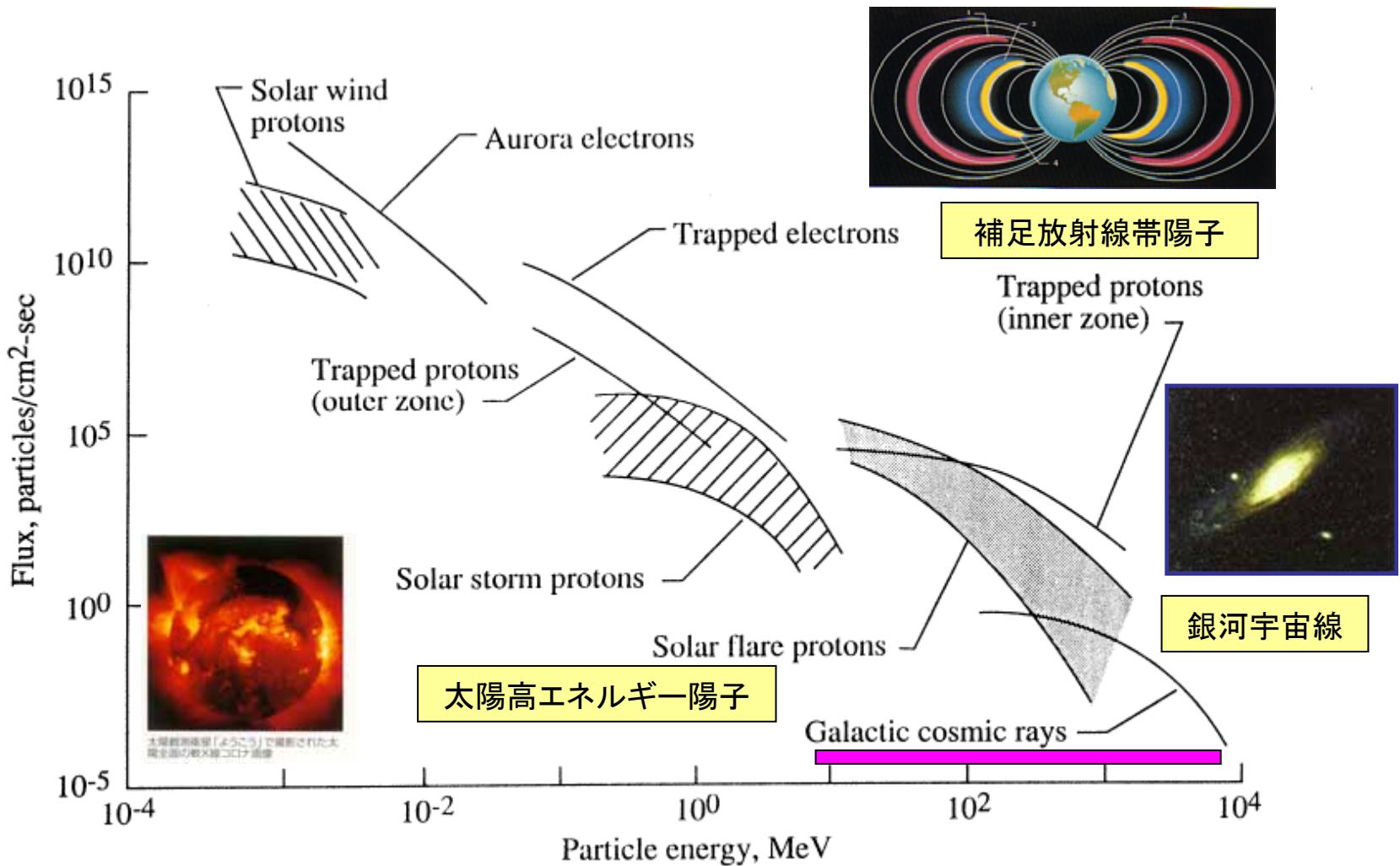


Sea level @ New York



Neutron flux @Tokyo  
about 12 n/cm<sup>2</sup> h  
for above 10 MeV

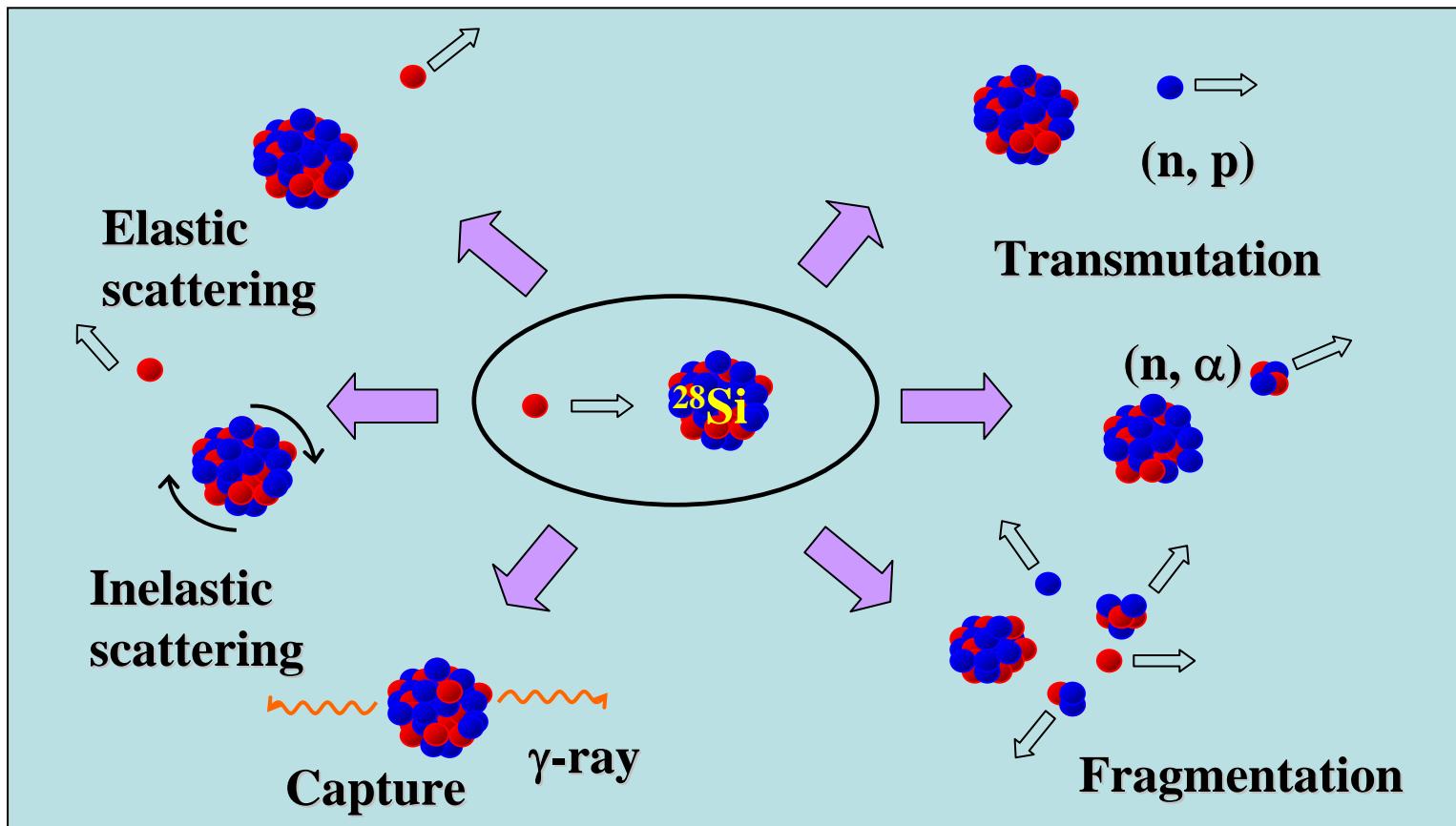
# Radiation flux in Space



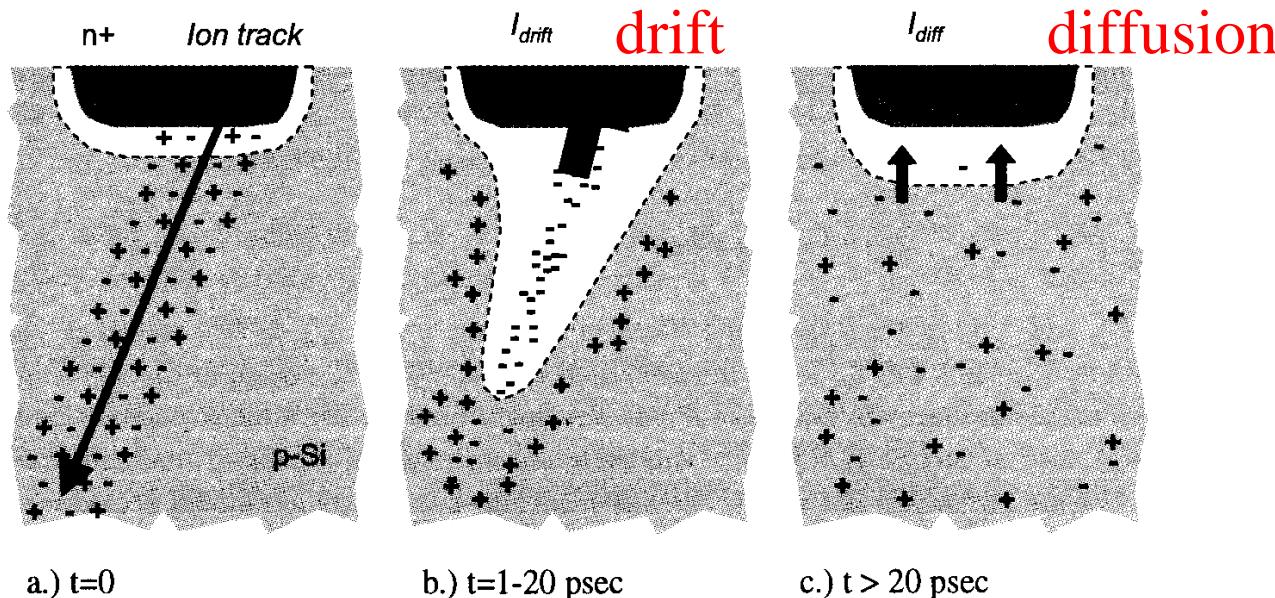
Ref.) K. Oishi, "Issues in space radiation shielding for linear base", JAERI-Conf95-016 (1995), p.125

# Nuclear processes relevant to SEUs

- Production of secondary charged particles and fragments via nuclear reactions with a silicon nucleus
- Data of their energy and angular distributions are necessary.



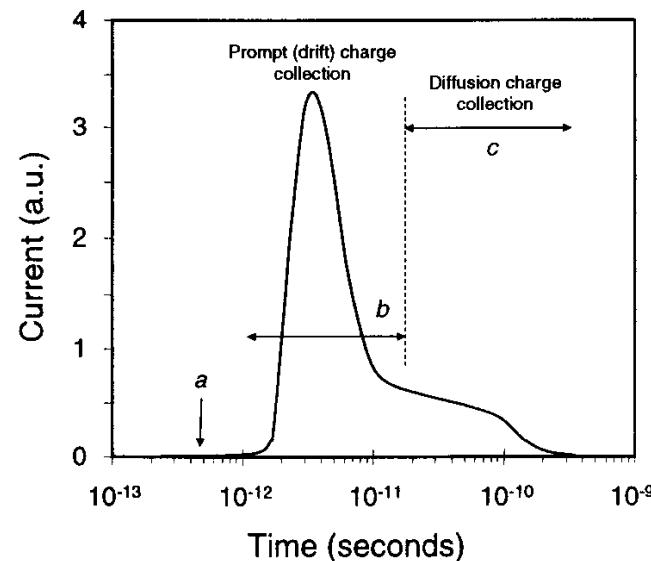
# Charge collection in a silicon junction



a.)  $t=0$

b.)  $t=1-20\text{ psec}$

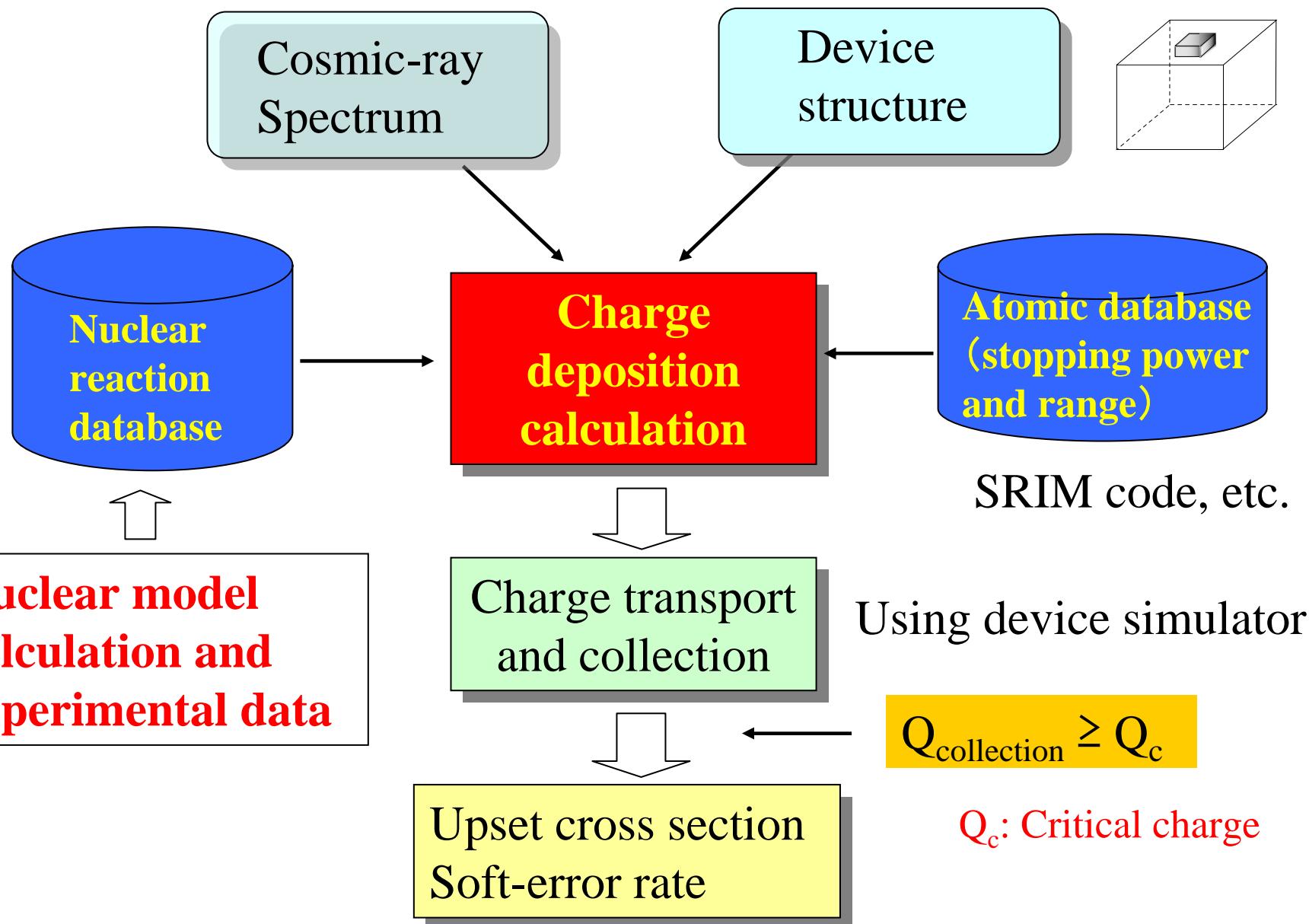
c.)  $t > 20\text{ psec}$



$$Q_{collection} = \int_0^{t_{max}} i(t) dt$$

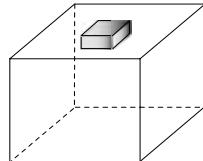
Ref.) Radiation effects and soft errors  
in integrated circuits and electronic  
devices, p.17

# Flow chart of SEU simulation



# Semi-empirical model

This model calculates nucleon-induced SEU cross section using experimental heavy-ion induced SEU data.



Barak et al., IEEE NS Vol. 43, No. 3, pp. 979-984 (1996).

Barak, IEEE NS Vol. 47, No. 3, pp. 545-550 (2000).

$$\begin{aligned}\sigma_{SEU}(E_{in}) &= N_{Si} \cdot \sigma_N(E_{in}) \int g(E_{in}, E_d, d) \sigma_{HI}(E_d) dE_d \\ &= N_{Si} \cdot \sigma_N(E_{in}) \cdot V_{int} \cdot \int g(E_{in}, E_d, d) h(E_d) dE_d\end{aligned}$$

The number of nuclear reactions in ROI per unit flux

$$\sigma_N(E_{in}) = \sigma_{el.}(E_{in}) + \sigma_{react.}(E_{in})$$

Normalized Heavy-ion SEU data

Distribution function of the energy deposited in the sensitive volume  
( $d$ : sensitive depth)

Dependence of charge collection efficiency on deposited energy

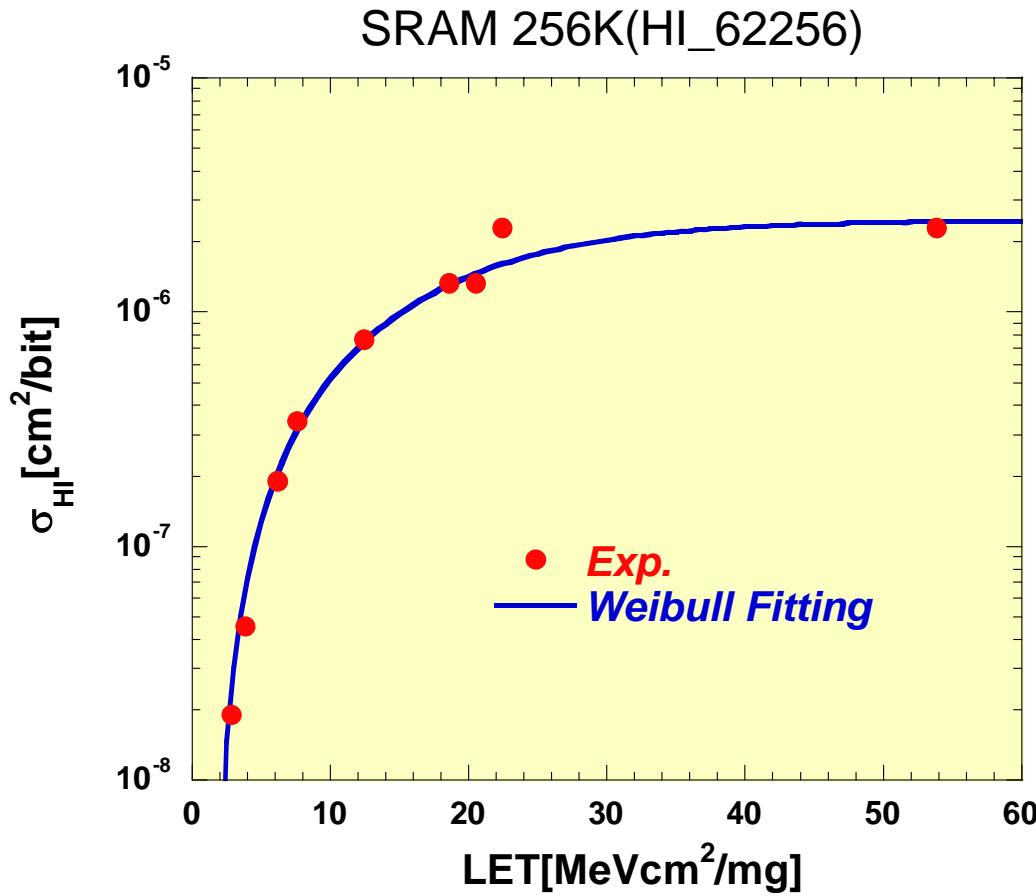
$$h(E_d) = \sigma_{HI}(E_d) / \sigma_{HI}^{\infty} = 1 - \exp \left\{ - \left[ \frac{E_d - E_0}{W} \right]^s \right\}$$

$$E_d = d \cdot LET$$

Weibull function

# HI-induced SEU cross section

$$\sigma_{HI}(L) = \sigma_{HI}^{\infty} \left( 1 - \exp \left\{ - \left[ \frac{L - L_0}{W} \right]^s \right\} \right)$$

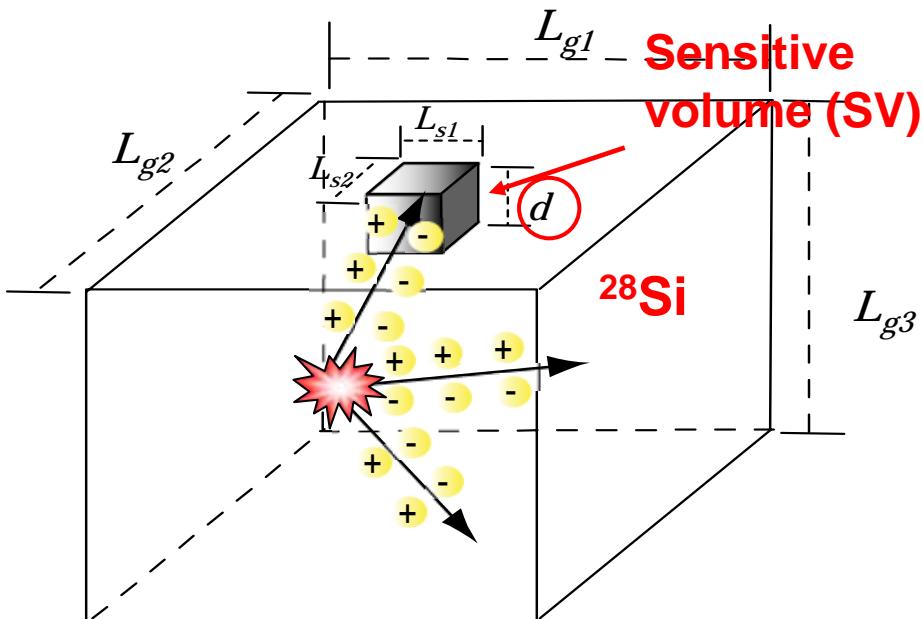


# Monte Carlo calculation

$$\sigma_{SEU}(E_{in}) = \int \sigma_{ED}(E_{in}, E_d, SV) \cdot h(E_d) dE_d$$

$$\sigma_{ED}(E_{in}, E_d, SV) \equiv N_{Si} \cdot V_{\text{int}} \cdot \sigma_{\text{reac}}(E_{in}) \cdot g(E_{in}, E_d, d)$$

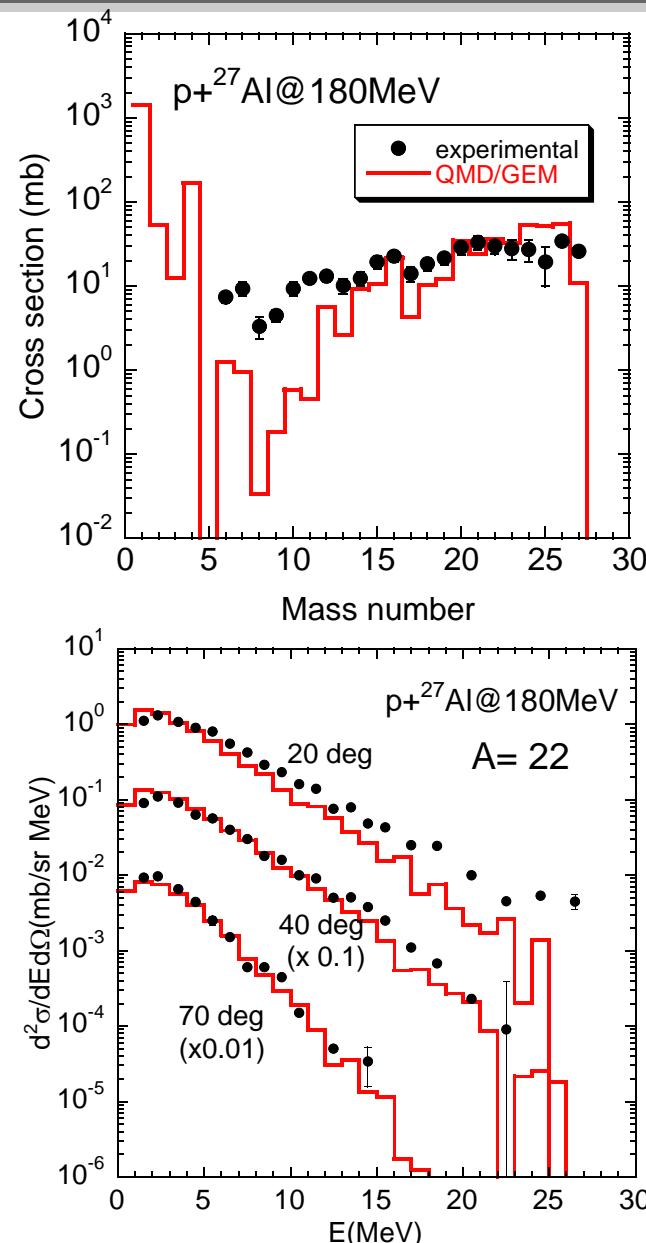
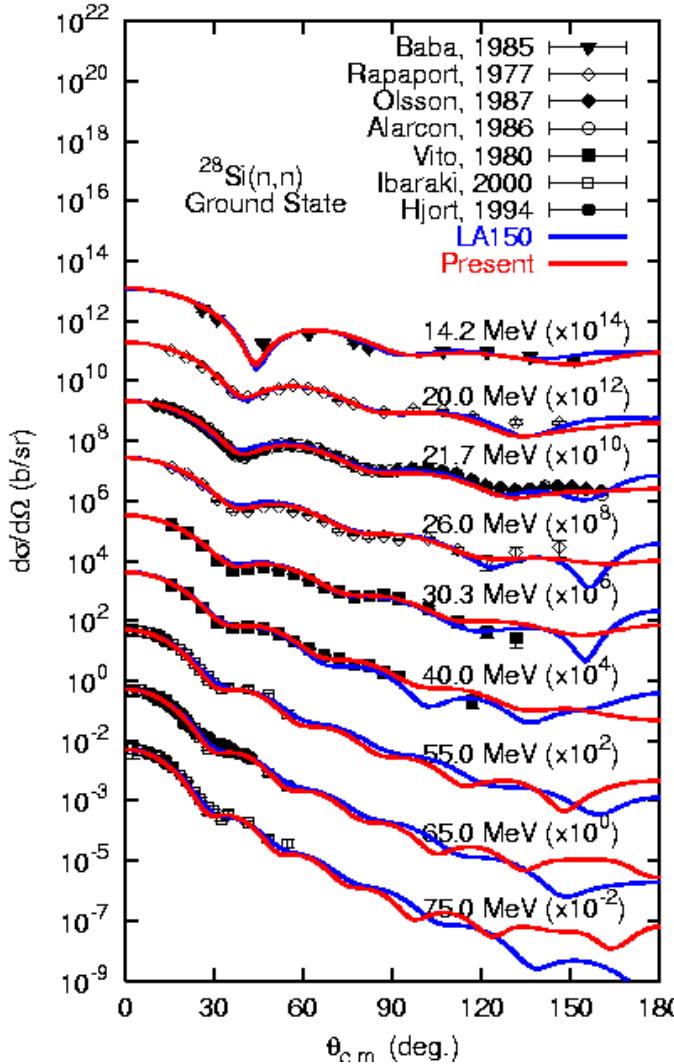
Rectangular parallelepiped geometry



- Random sampling of a reaction point
- Nuclear reaction event generation (secondary ion, energy and angle) using **nuclear reaction database created by QMD/GEM calculation and JENDL/HE-2004 for elastic scattering (exclusive, inclusive)**
  - Up to 1 GeV
- Energy deposition due to secondary ion using  **$dE/dx$  and range calculated by SRIM code**

# Nuclear reaction database

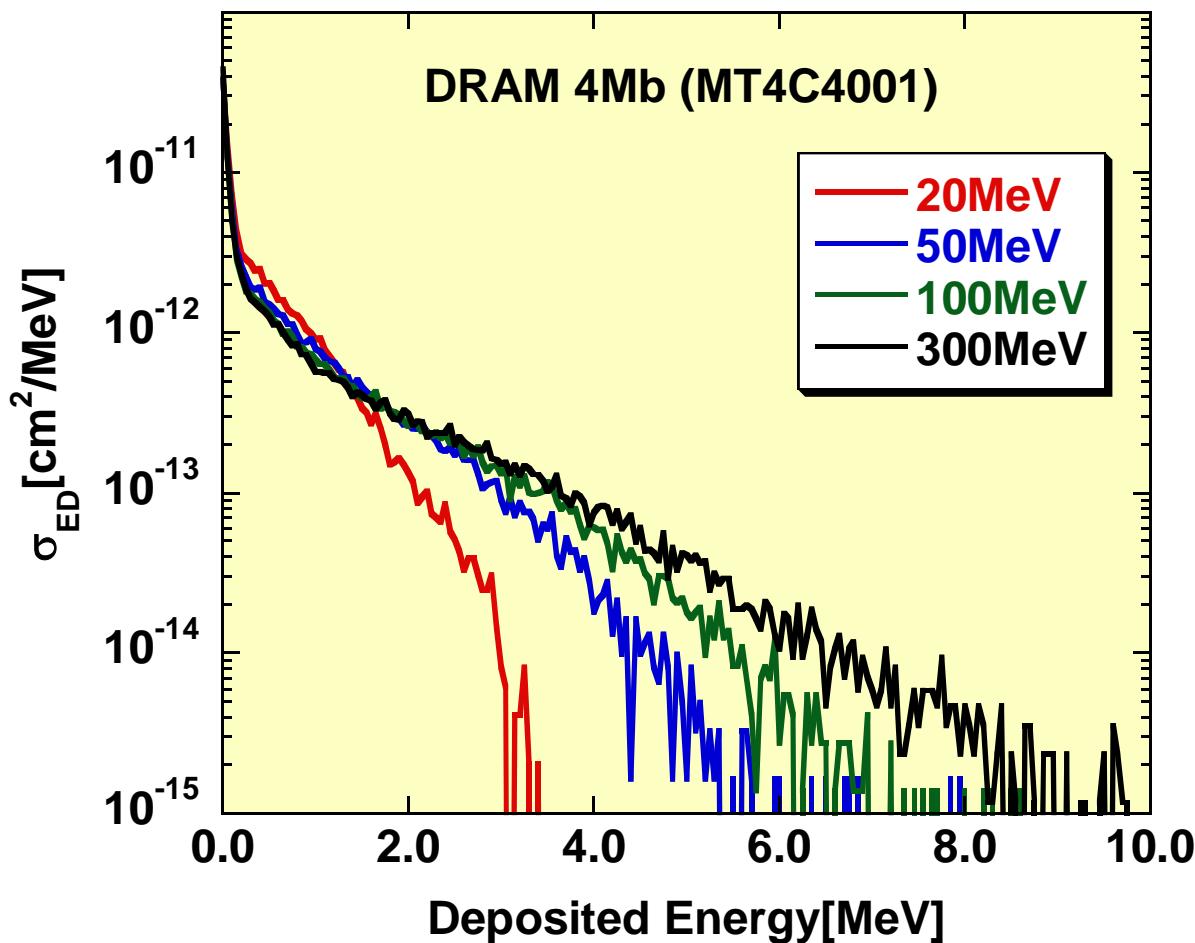
## Neutron elastic scattering (JENDL/HE-2004)



Ref.: K. Kwiatkowski et al.  
PRL 50, 1648 (1983)

# Incident energy dependence of energy deposition spectra

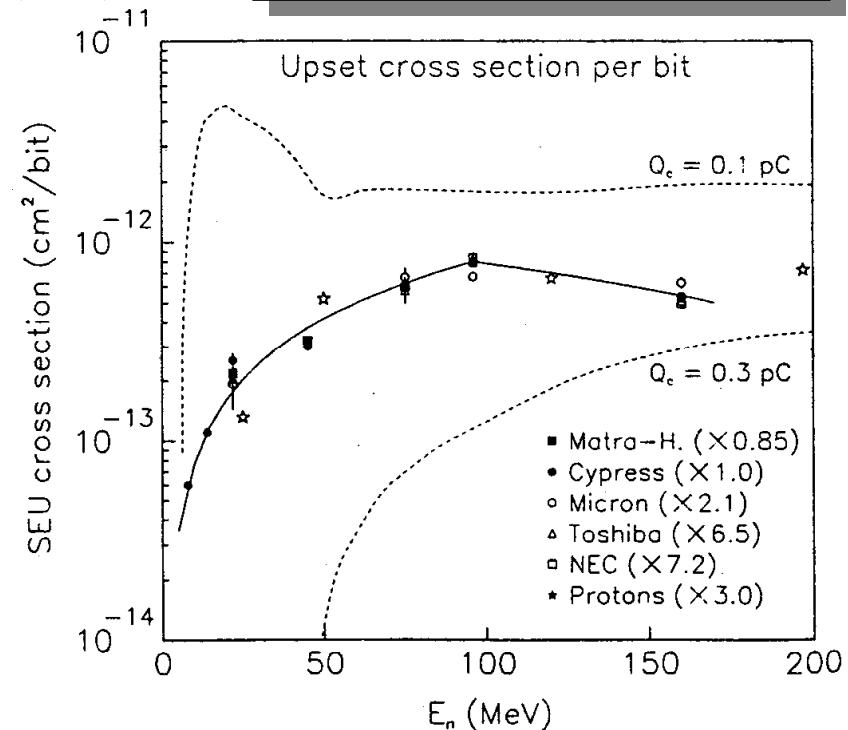
- Proton incidence
- Sensitive Volume :  $V = \sigma_{HI}^{\infty} \cdot d = 5.57 \times 5.57 \times 2 \mu\text{m}^3$



# Experimental SEU cross sections

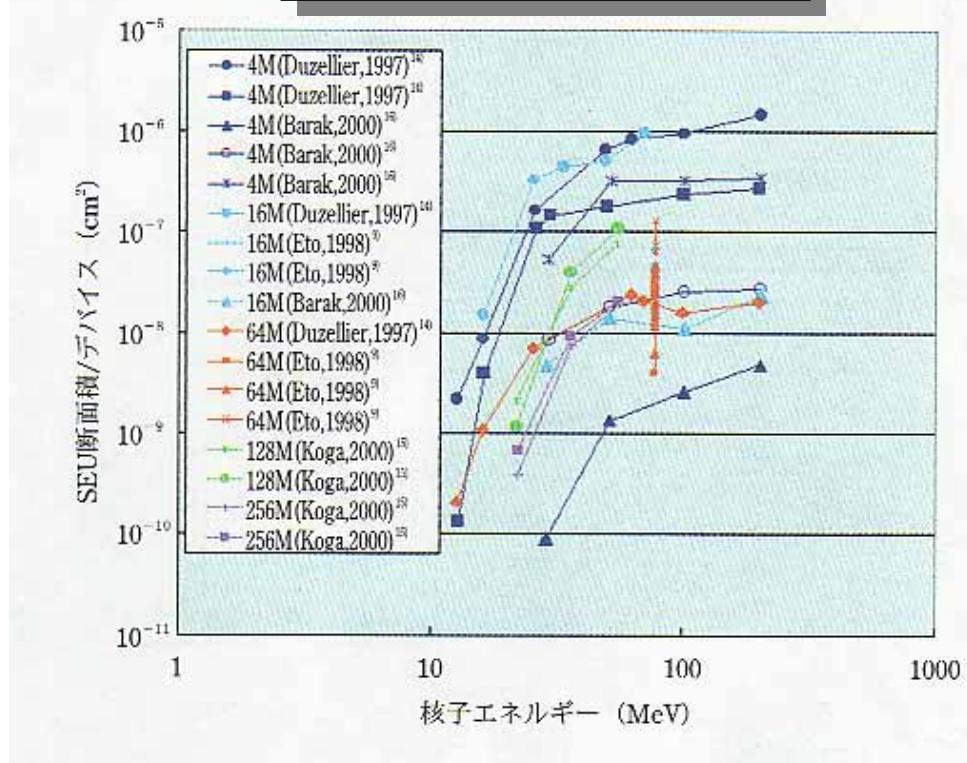
## SRAM

### Neutron irradiation



## DRAM

### Proton irradiation

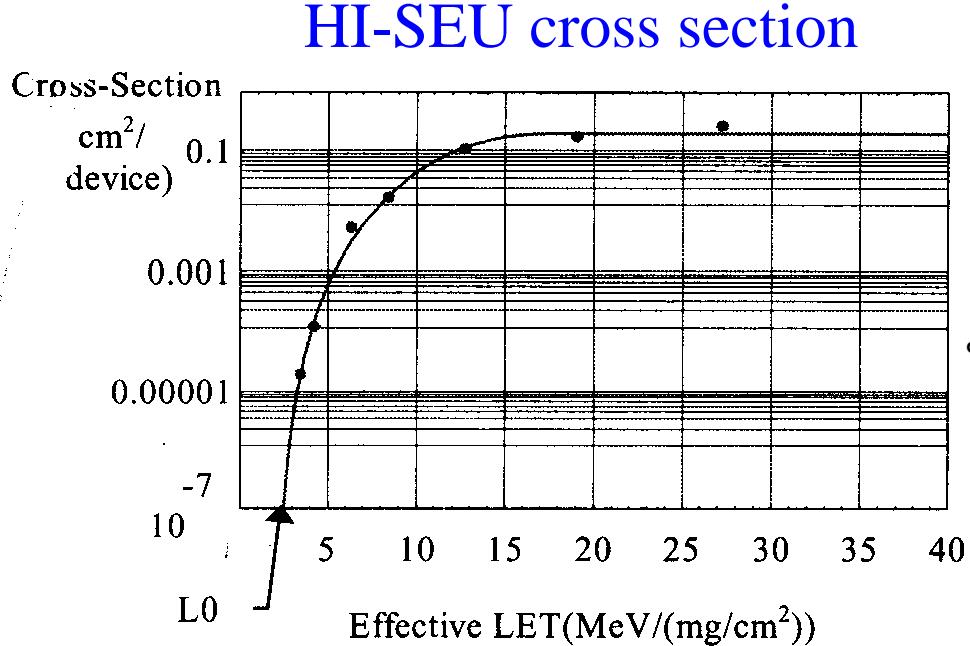


Ref.) K. Johansson et al., IEEE Trans. Nucl. Sci. 45, 2519 (1998).

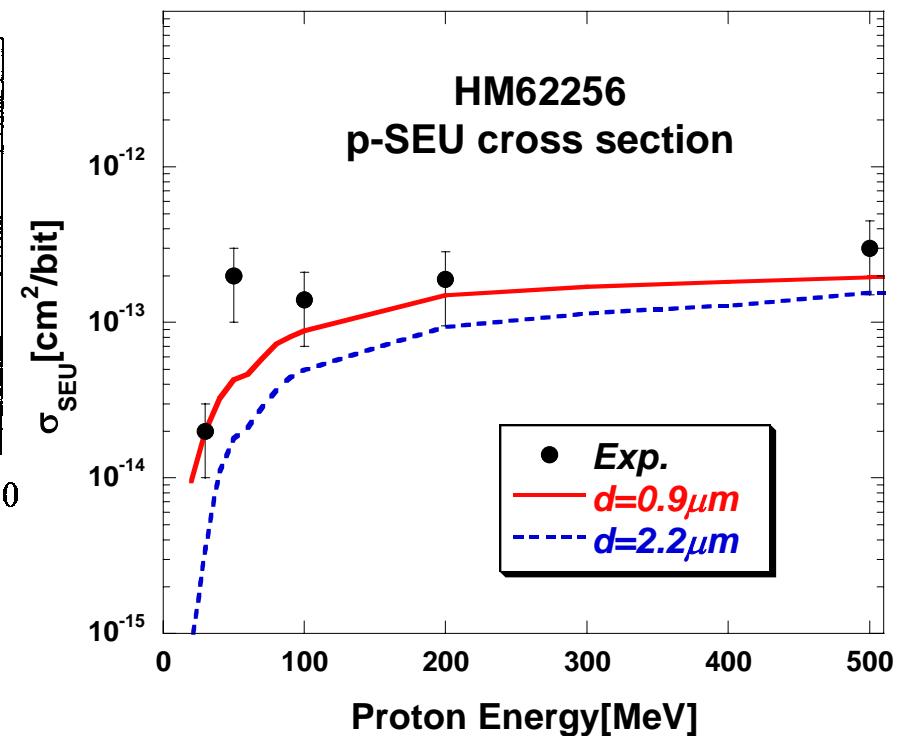
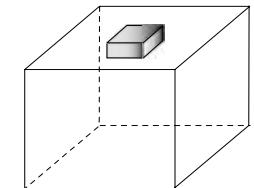
引用) 伊部ら、応用物理 Vol.70, No.11 (2001)

# Comparison with experimental data (I)

32K x 8 bit SRAM (HM62256)

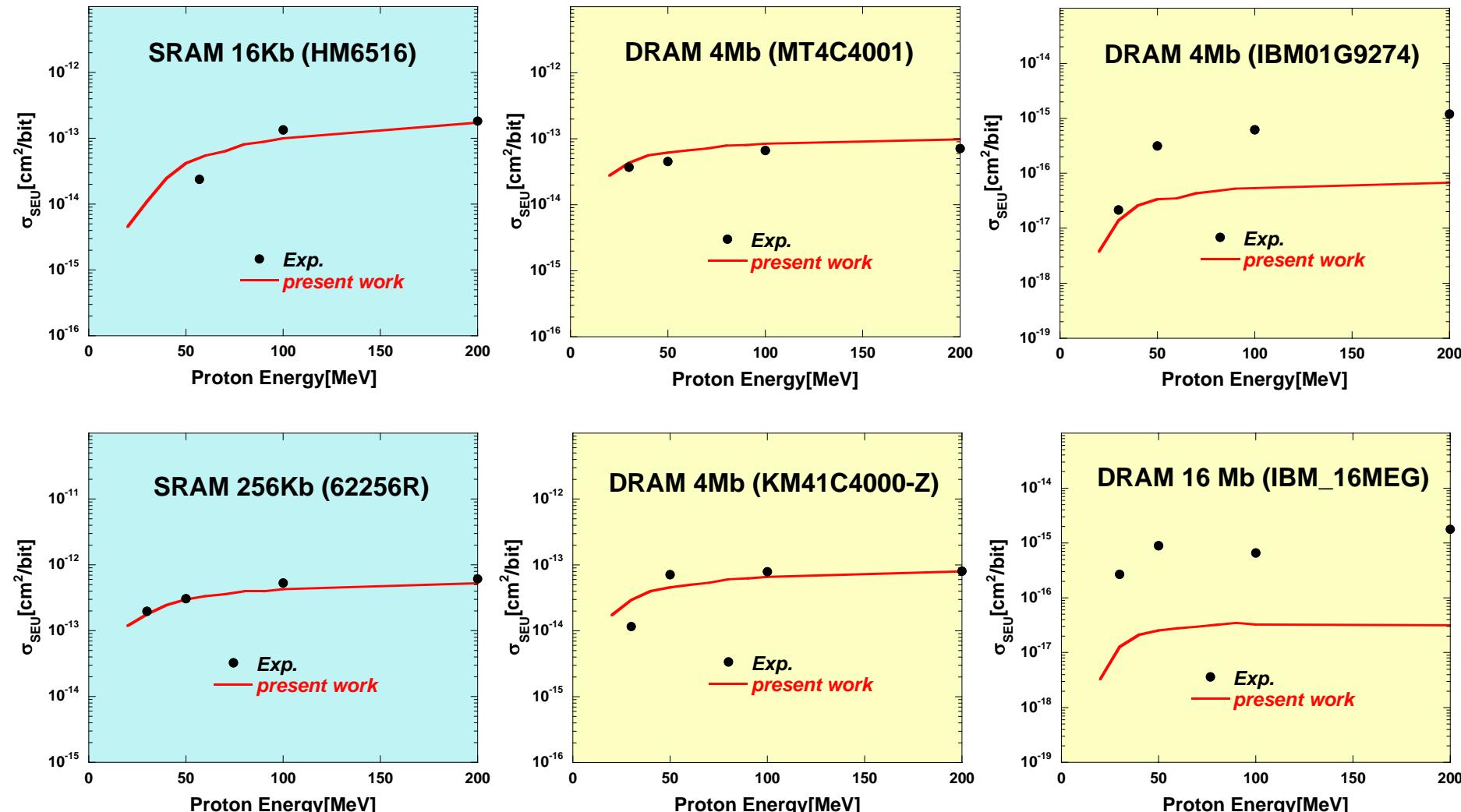


Sensitive area =  $\sigma_{HI}^{\infty} = 76.2 \mu m^2$   
 $d = 2.2$  or  $0.9 \mu m$



# Comparison with experimental data (II)

Sensitive depth = 2  $\mu$ m



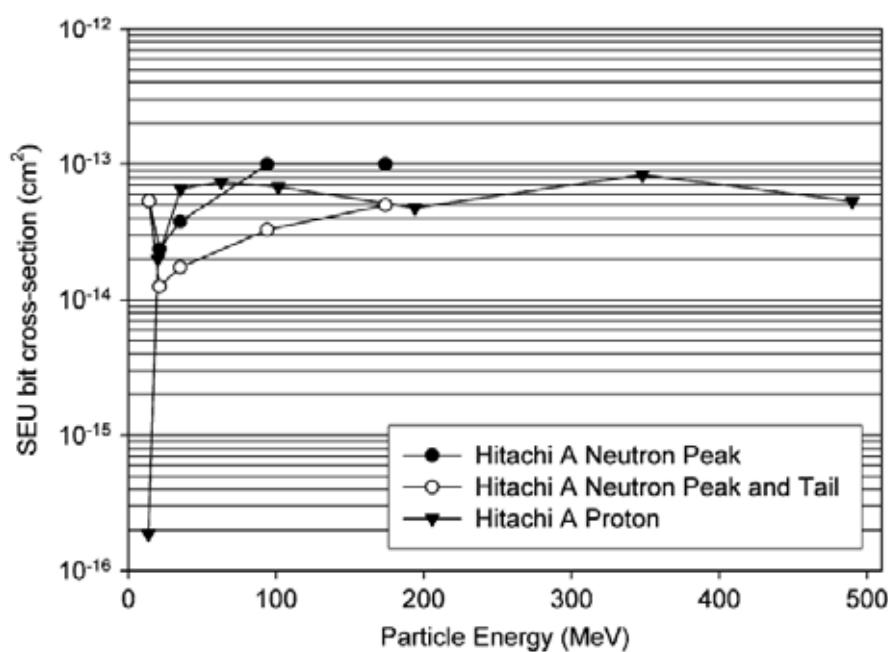
# Discussion

---

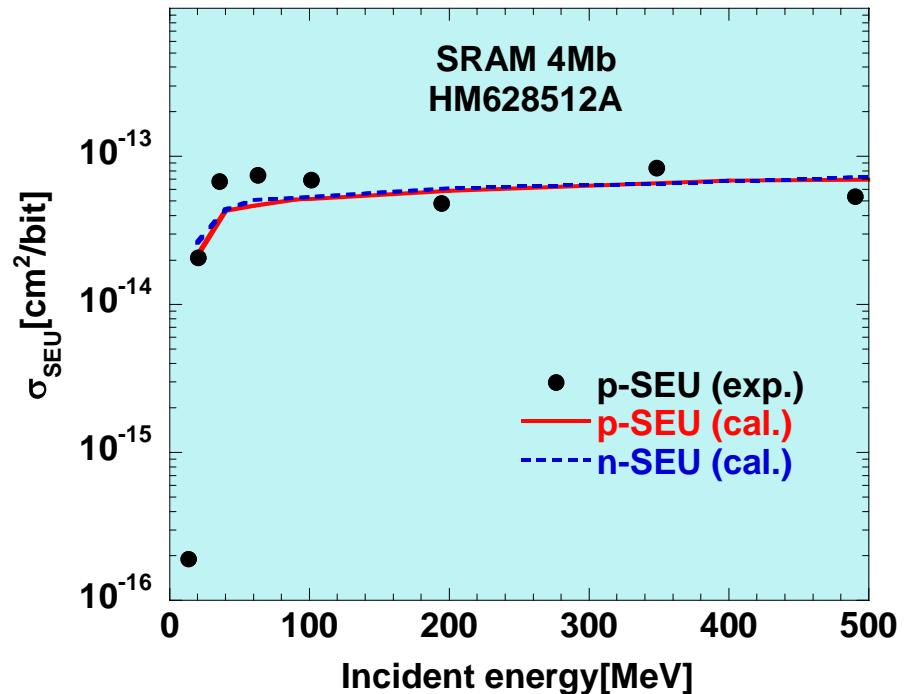
- (a) Difference in **n-SEU and p-SEU**
- (b) Effect of **elastic scattering** on SEU
- (c) **Incident energy dependence of secondary ions** having significant contribution to SEU
- (d) Effect of **simultaneous multiple ions emission**
  - *Inclusive (conventional) nuclear data*
  - vs Exclusive (event-by-event)* -

# (a) n-SEU and p-SEU

4Mb SRAM, 0.5  $\mu\text{m}$   
(HM628512ALP-7)

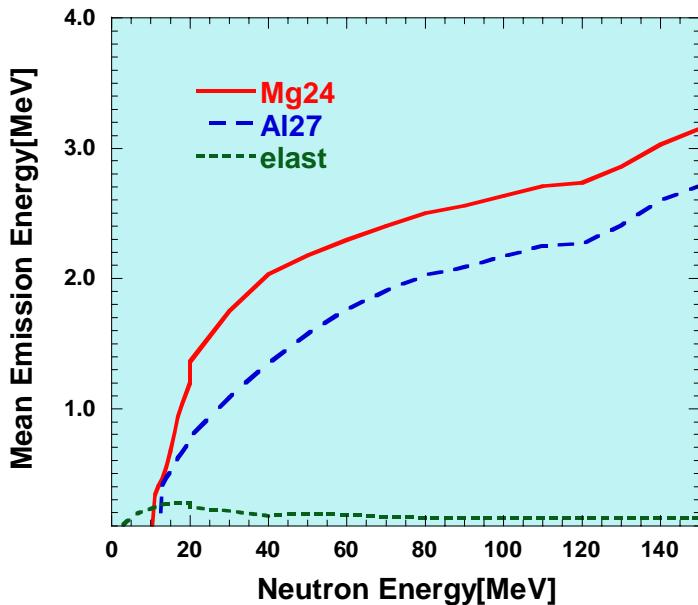
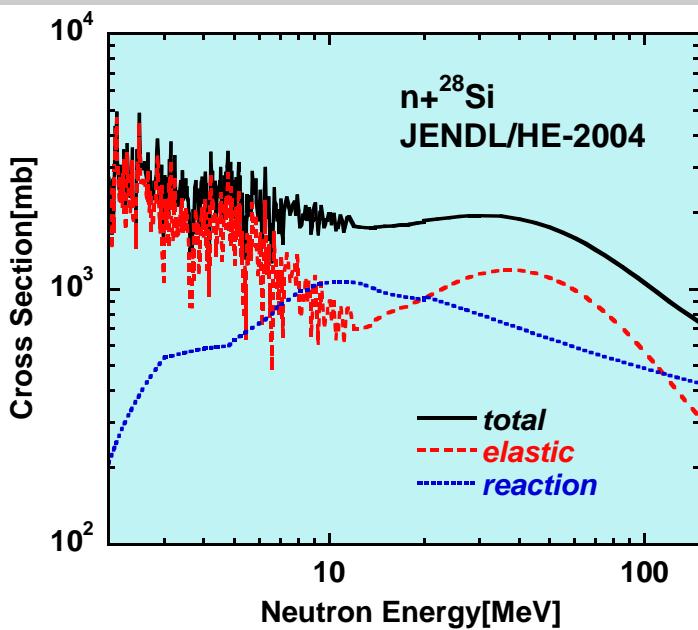


Sensitive depth = 2  $\mu\text{m}$

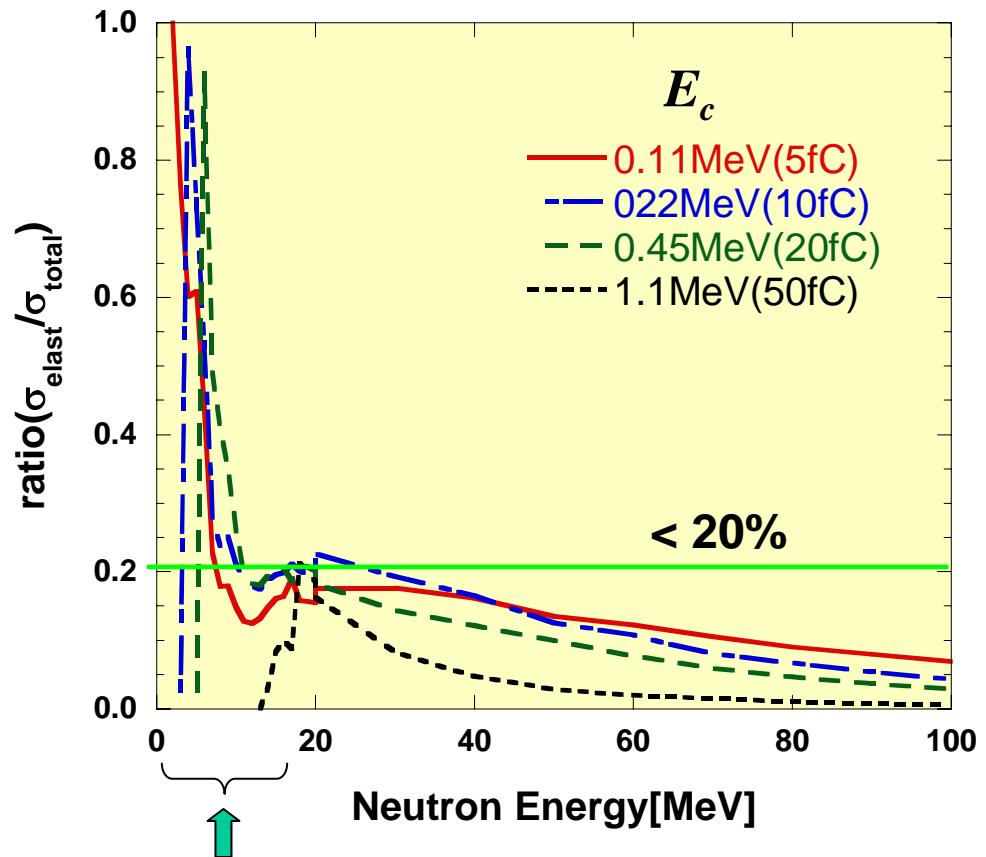


Ref.) C.S. Dyer et al., IEEE NS Vol.51, No.5, 2817 (2004)

# (b) Effect of elastic scattering



Sensitive volume:  $1 \times 1 \times 1 \mu\text{m}^3$

$$h(E_d) = \Theta(E_d - E_c)$$


Threshold energy region for SEU  $< 20$  MeV

### (c) Incident energy dependence of secondary ions having significant contribution to SEU

**p-SEU**

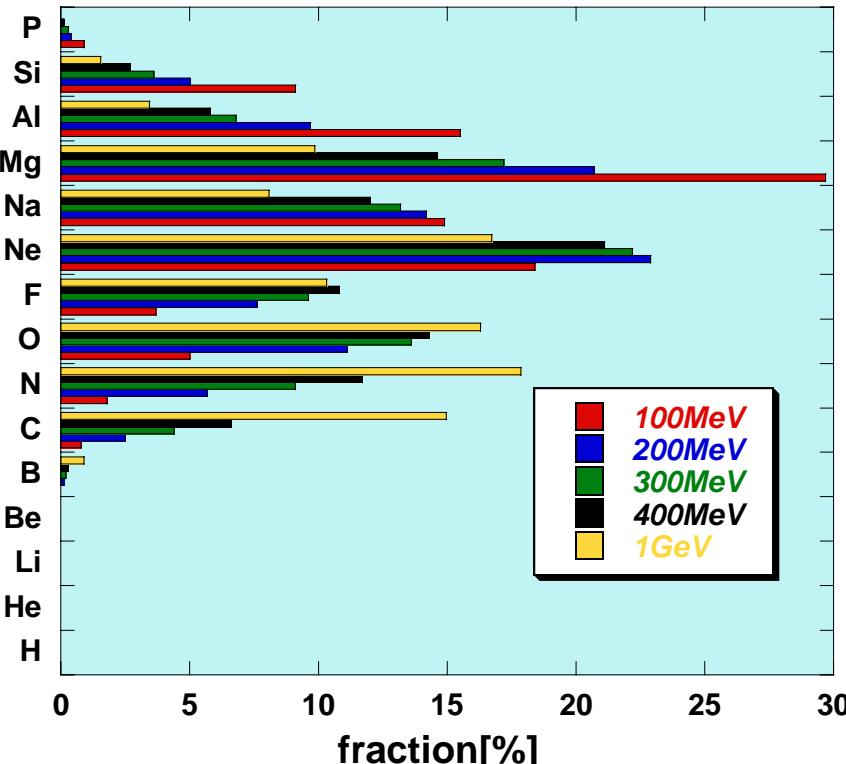
$$h(E_d) = \Theta(E_d - E_c)$$

Cubic geometry:  $L_g = 10 \mu\text{m}$  (interaction region)

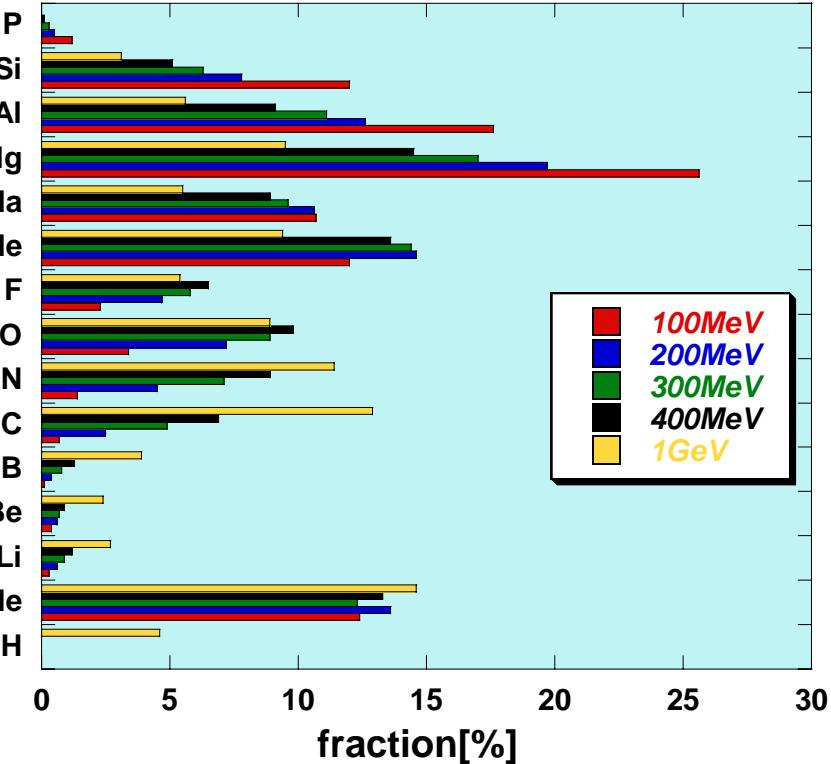
$L_s = 1 \mu\text{m}$  (sensitive region)

**(1)  $Q_c = 50 \text{ fC (1.1 MeV)}$**

Secondary Ion



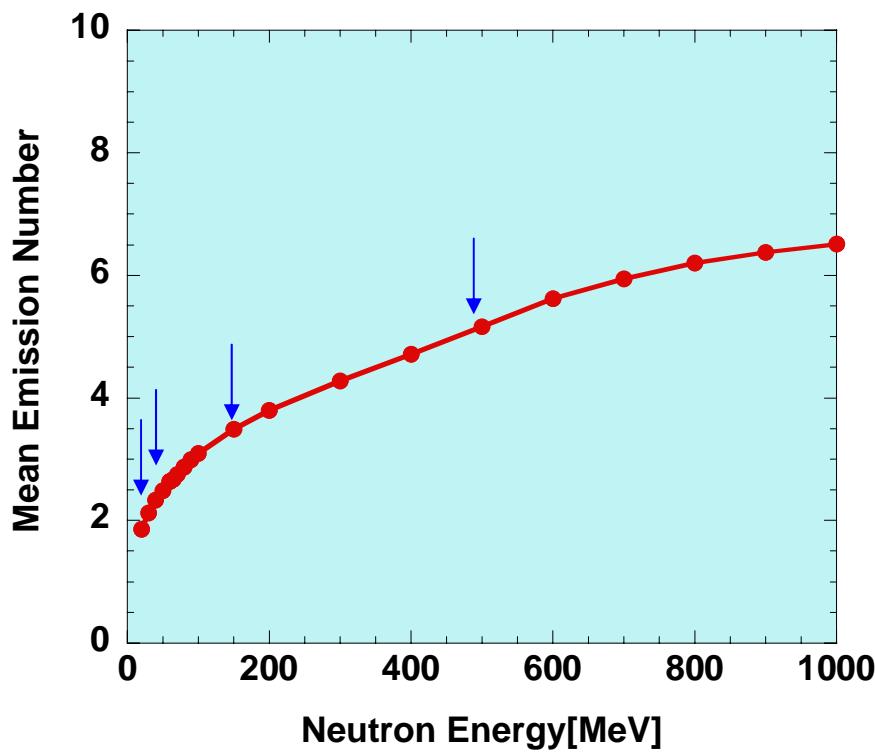
**(2)  $Q_c = 10 \text{ fC (0.22 MeV)}$**



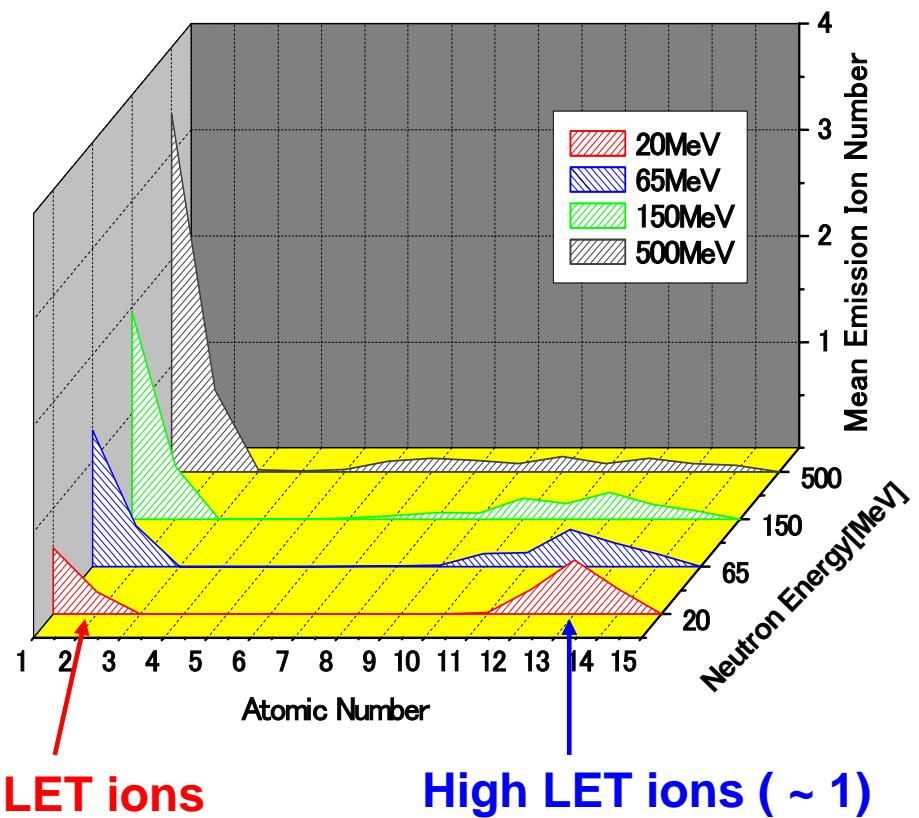
# (d) Effect of simultaneous multiple ions emission

JQMD/GEM calculation for  $n + {}^{28}\text{Si}$  reaction

Mean number of secondary ions



Dependence of atomic number



# Inclusive data vs Exclusive data

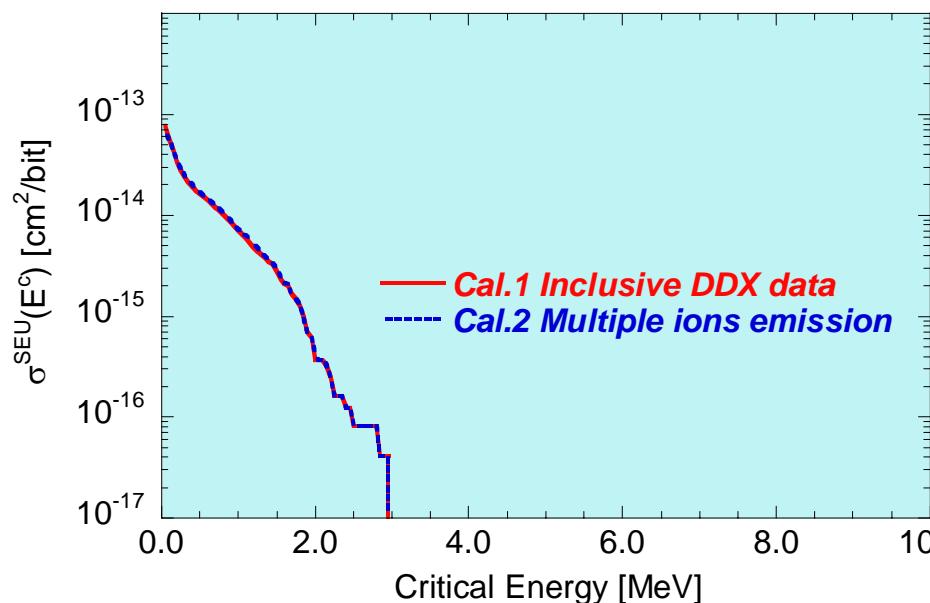
## SEU cross sections as a function of critical energy $E_c$

$$h(E_d) = \Theta(E_d - E_c)$$

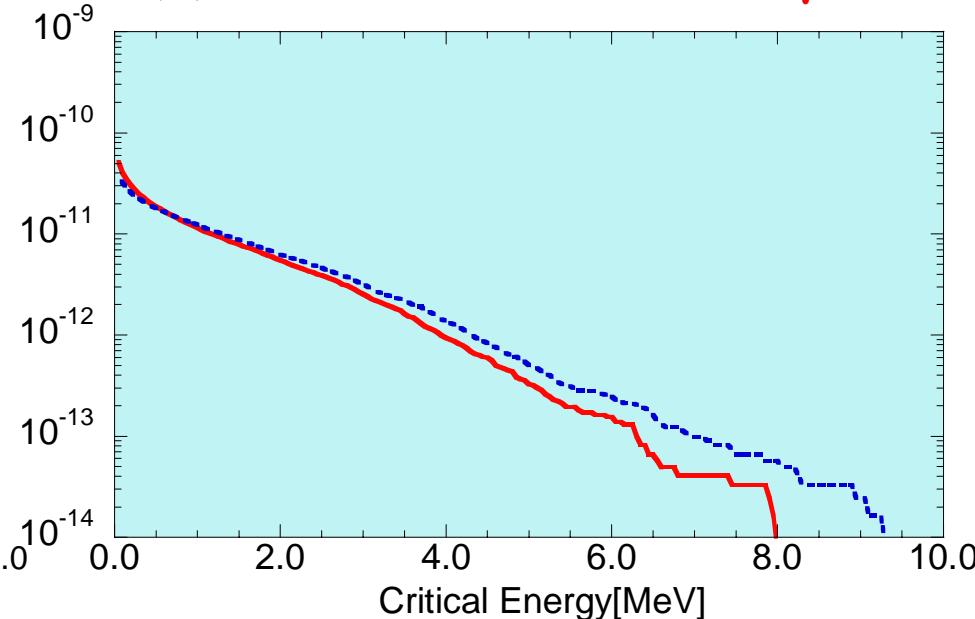
$$\sigma_{SEU}(E_n, E_c) = \int \sigma_{ED}(E_n, E_d, SV) \cdot h(E_d) dE_d = \int_{E_c}^{\infty} \sigma_{ED}(E_n, E_d, SV) dE_d$$

$E_n = 150$  MeV

(1)  $SV = 1.0 \times 1.0 \times 1.0 \mu\text{m}^3$



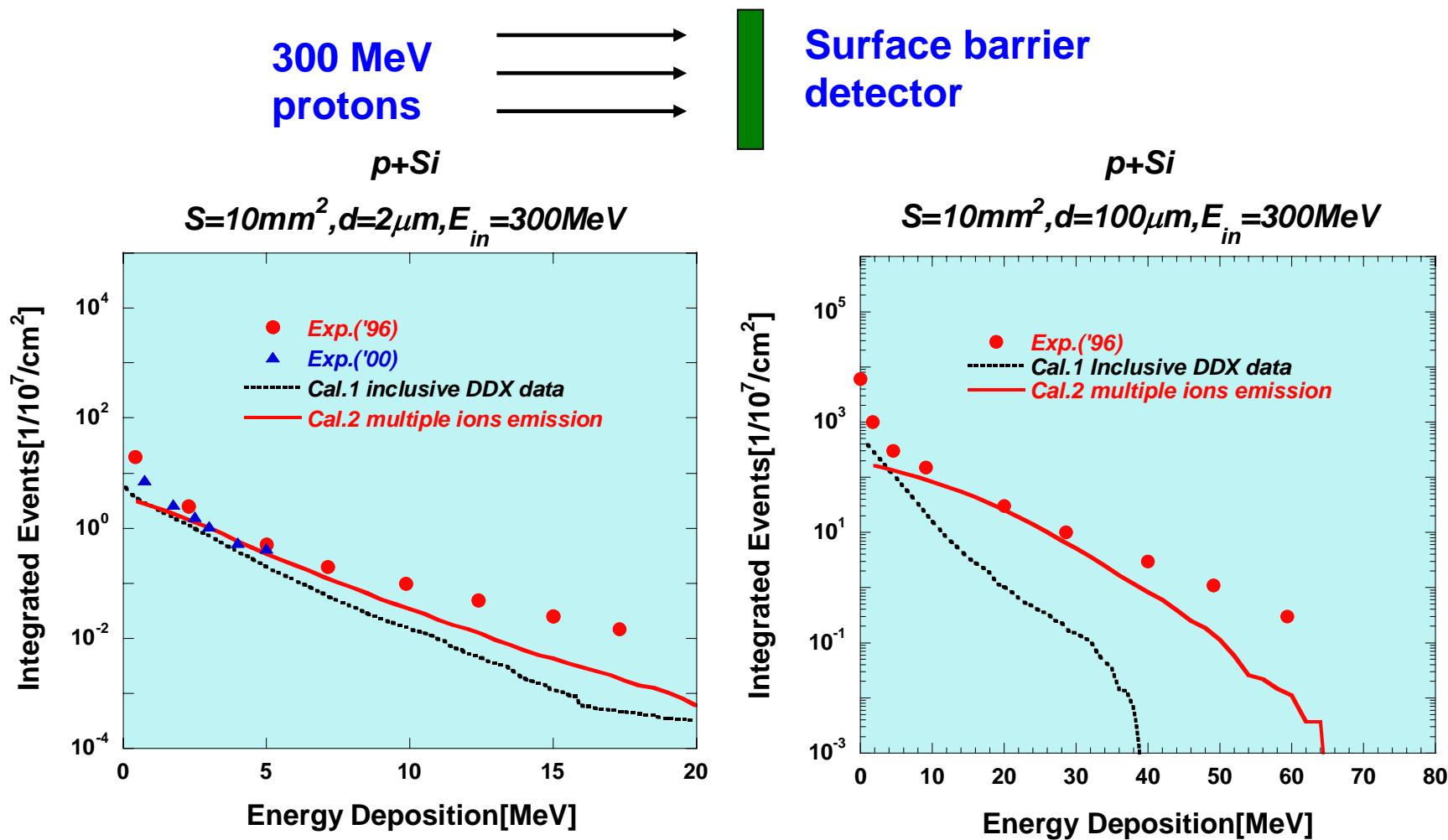
(2)  $SV = 20.0 \times 20.0 \times 1.0 \mu\text{m}^3$



$$Q_c [\text{fC}] = 44.4 * E_c [\text{MeV}]$$

# Energy deposition spectrum of Si detector

(Inclusive DDX data .vs. Multiple ions emission)



Exp.data : J. Barak et al., IEEE Trans. on Nucl. Sci. **43**, No.3 (1996) p.979; *ibid.*, **47**. No.3 (2000), p.545.

# Summary

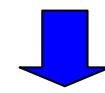
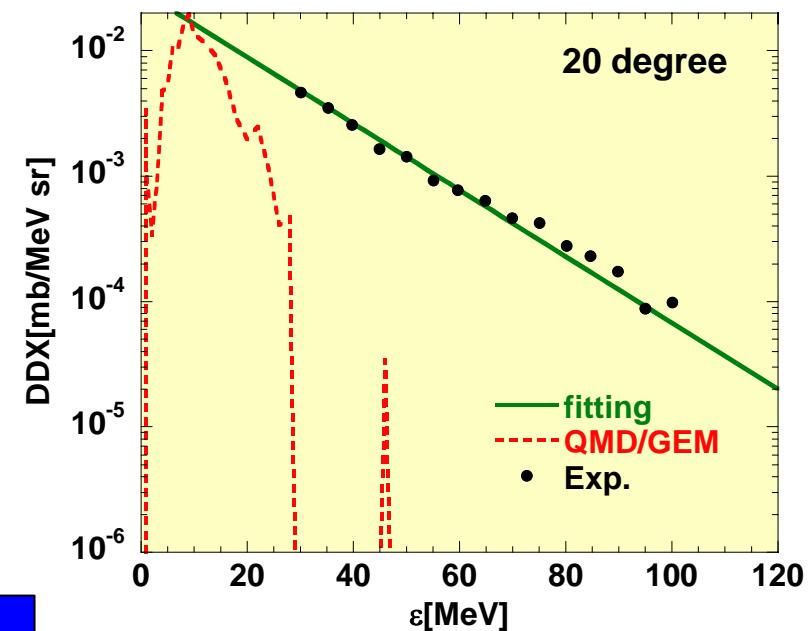
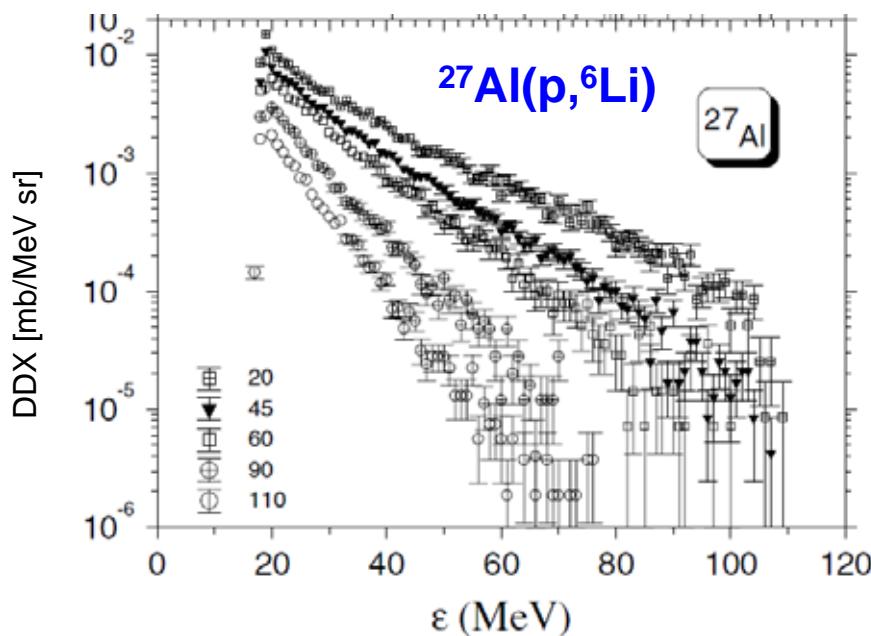
---

- Overview of nucleon-induced single-event upset phenomena
- Calculation of SEU cross sections using the semi-empirical model based on the sensitive volume concept
- Influences of the nuclear data on SEU simulation:
  - (a) n-SEU vs p-SEU
  - (b) elastic scattering
  - (c) secondary reaction products
  - (d) multiple ions emission : inclusive vs exclusive

# Future : Nuclear data

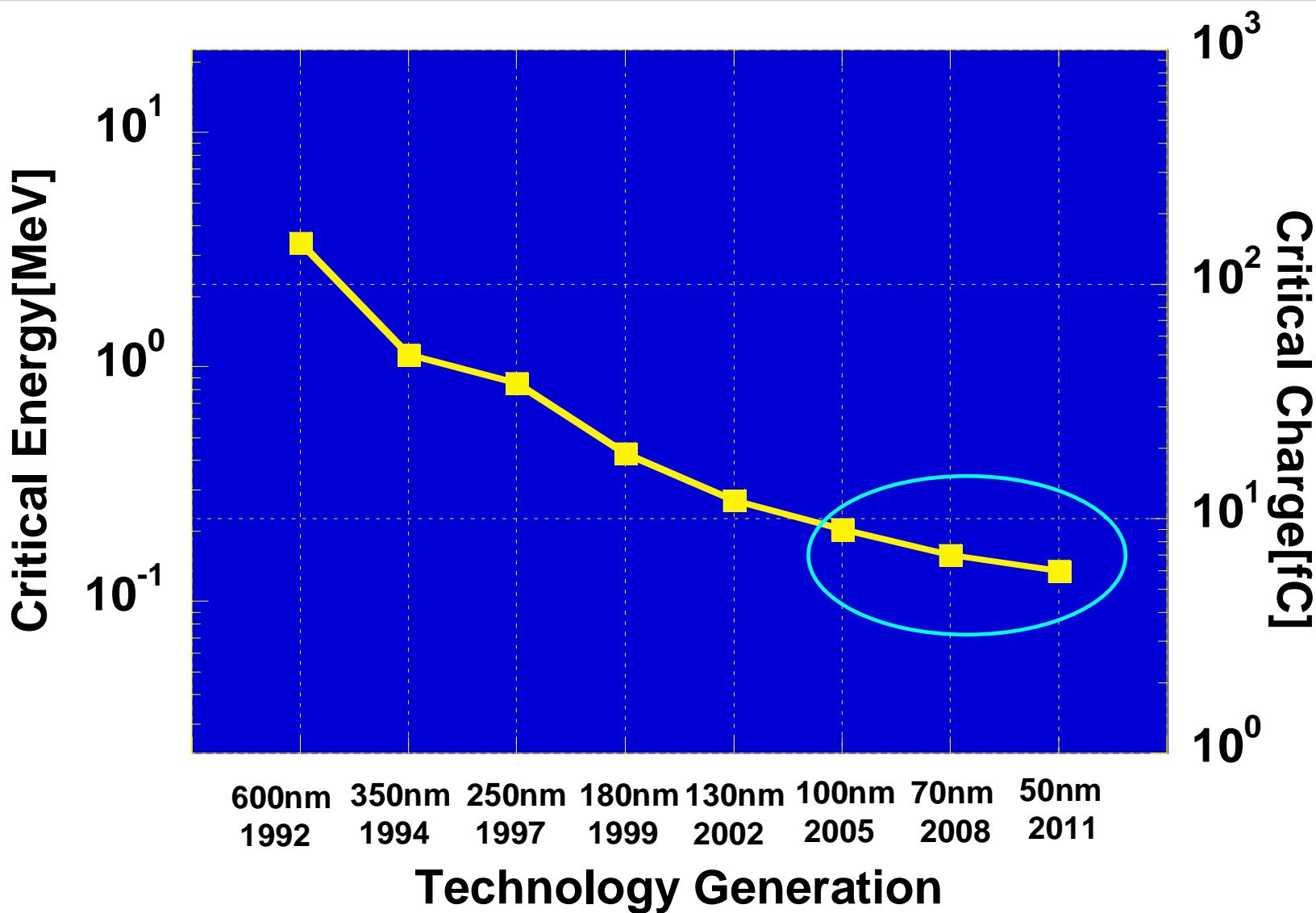
- More measurements of DDXs of secondary ions over the wide mass range are required for testing the predictions of reaction models and their refinement.

H. Machner et al., PRC 73, 044606 (2006): He, Li, Be, B from 200 MeV p+Al

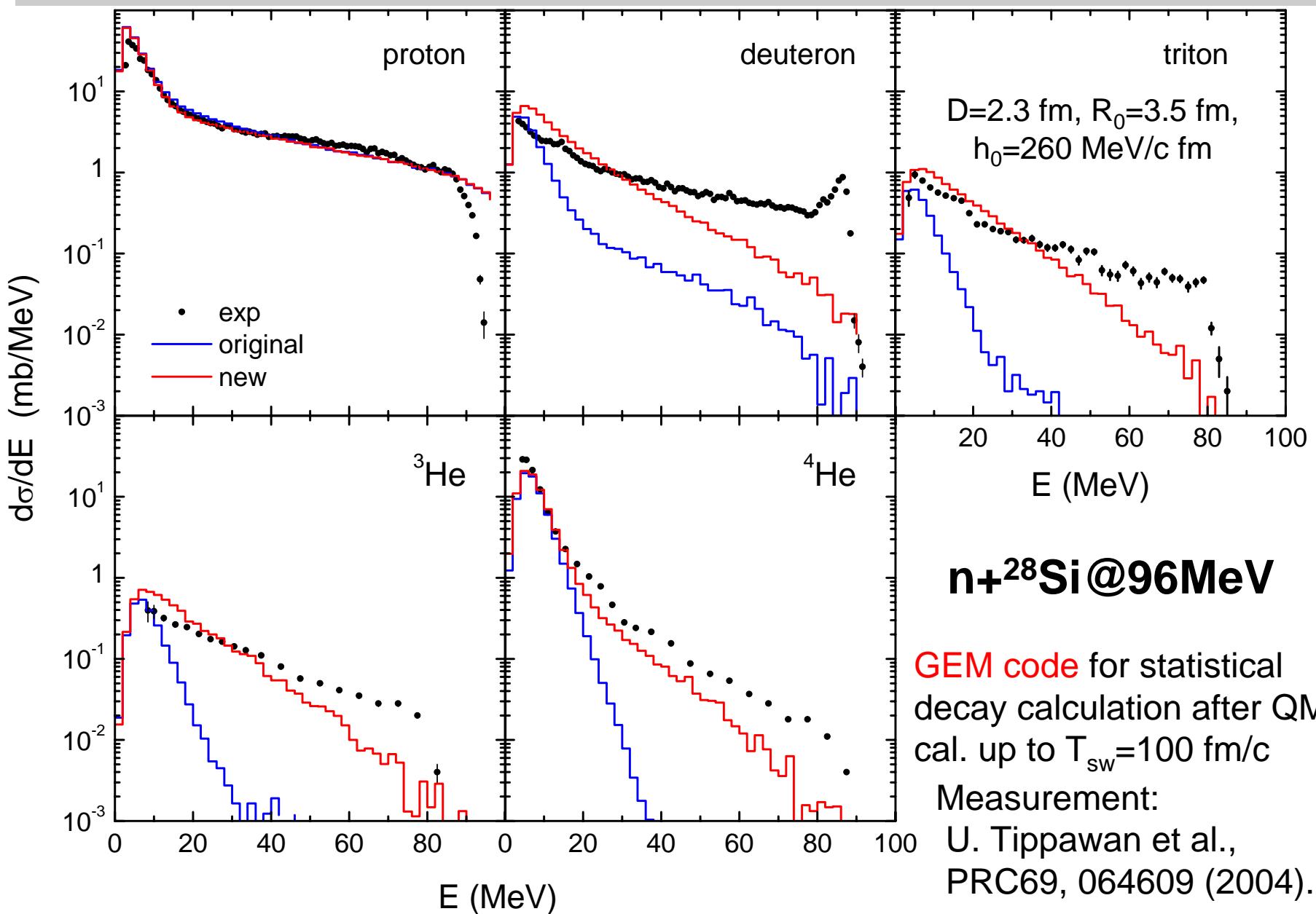


Proposal of a new experiment using the inverse kinematics  
@RIBF, RIKEN  $\rightarrow$   ${}^{28}\text{Si}({}^1\text{H}, \text{X})$

# Critical charge for SRAM

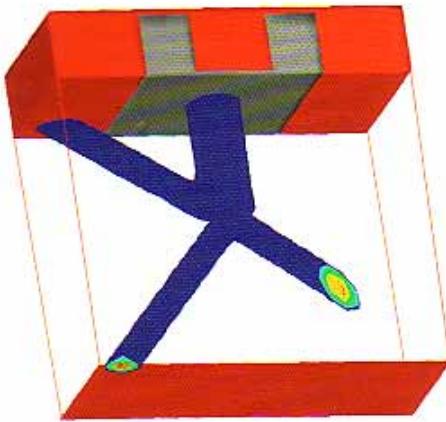


# Improvement of QMD calculation



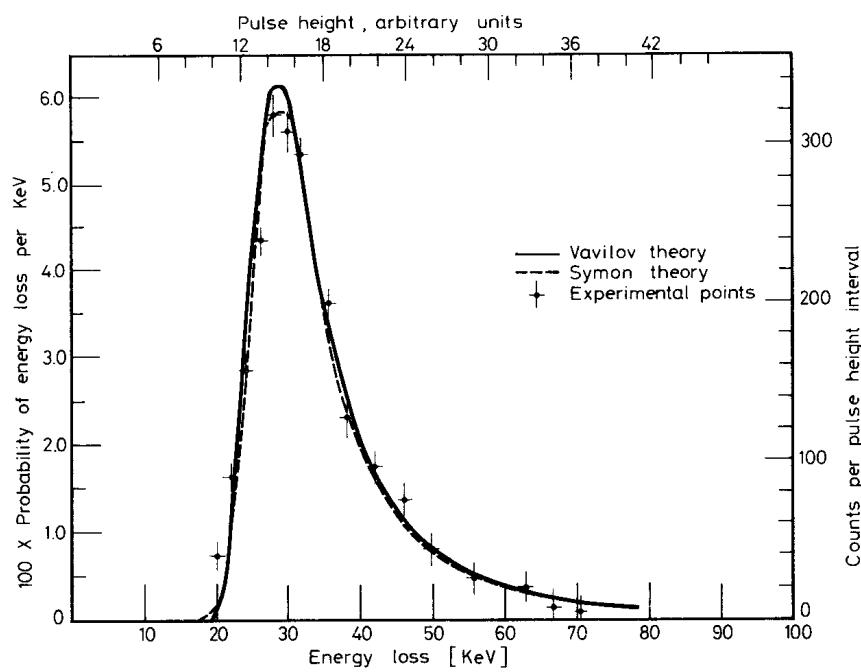
# Future : energy-deposition process

Spatial distribution of initially-deposited charges



track structure effect

Energy straggling



1 μm Si cube

100MeV proton

R.A. Weller et al., IEEE Nucl. Sci. 50 (2003).

